

DATA SHEET

74ABT843

9-bit interface latch with set and reset
(3-State)

Product specification

Supersedes data of 1995 Sep 06
IC23 Data Handbook

1998 Jan 16

9-bit bus interface latch with set and reset (3-State)

74ABT843

FEATURES

- High speed parallel latches
- Extra data width for wide address/data paths or buses carrying parity
- Ideal where high speed, light loading, or increased fan-in are required with MOS microprocessors
- Slim DIP 300 mil package
- Broadside pinout
- Output capability: +64mA/-32mA
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model
- Power-up 3-State
- Power-up reset

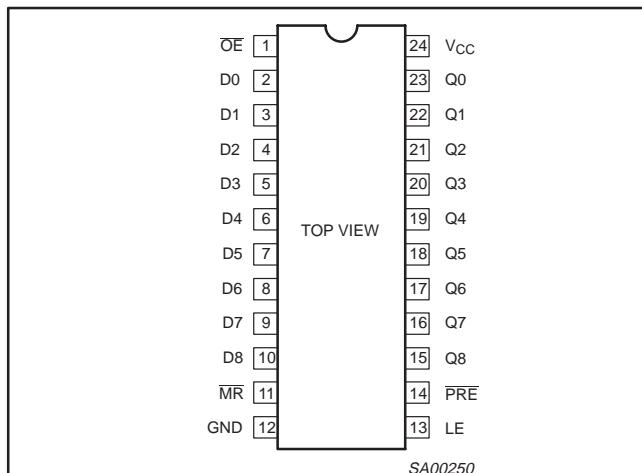
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS $T_{amb} = 25^\circ\text{C}$; $\text{GND} = 0\text{V}$	TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay D_n to Q_n	$C_L = 50\text{pF}$; $V_{CC} = 5\text{V}$	5.0	ns
C_{IN}	Input capacitance	$V_I = 0\text{V}$ or V_{CC}	4	pF
C_{OUT}	Output capacitance	Outputs disabled; $V_O = 0\text{V}$ or V_{CC}	7	pF
I_{CCZ}	Total supply current	Outputs disabled; $V_{CC} = 5.5\text{V}$	500	nA

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
24-Pin Plastic DIP	−40°C to +85°C	74ABT843 N	74ABT843 N	SOT222-1
24-Pin plastic SO	−40°C to +85°C	74ABT843 D	74ABT843 D	SOT137-1
24-Pin Plastic SSOP Type II	−40°C to +85°C	74ABT843 DB	74ABT843 DB	SOT340-1
24-Pin Plastic TSSOP Type I	−40°C to +85°C	74ABT843 PW	74ABT843PW DH	SOT355-1

PIN CONFIGURATION



DESCRIPTION

The 74ABT843 Bus interface latch is designed to eliminate the extra packages required to buffer existing registers and provide extra data width for wider data/address paths of buses carrying parity.

The 74ABT843 consists of nine D-type latches with 3-State outputs. In addition to the LE and OE pins, it has a Master Reset (MR) pin and Preset (PRE) pin. These pins are ideal for parity bus interfacing in high performance systems. When MR is Low, the outputs are Low if OE is Low. When MR is High, data can be entered into the latch. When PRE is Low, the outputs are High, if OE is Low. PRE overrides MR .

QUICK REFERENCE DATA

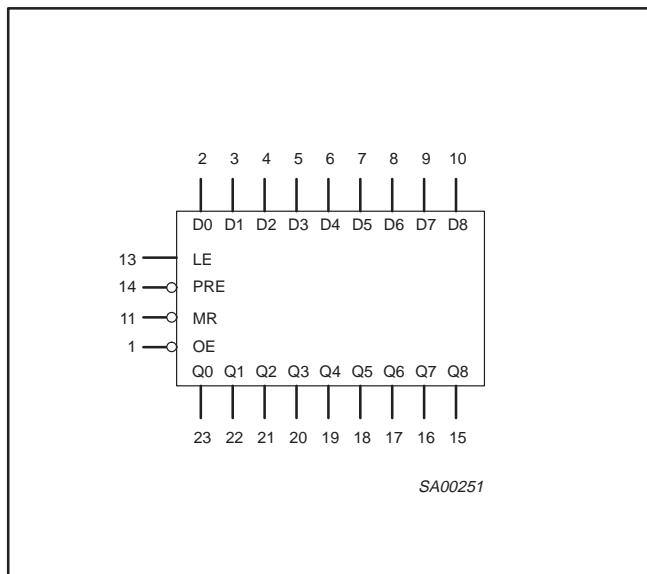
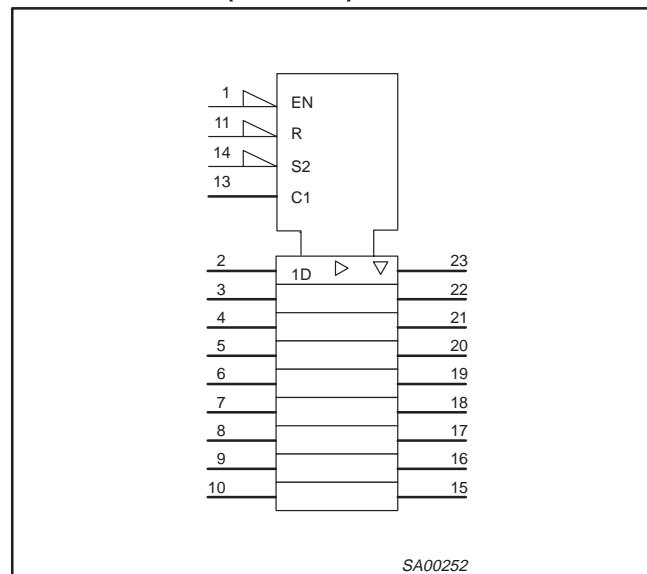
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C_{OUT}	Output capacitance	Outputs disabled; $V_O = 0\text{V}$ or V_{CC}	7	pF
I_{CCZ}	Total supply current	Outputs disabled; $V_{CC} = 5.5\text{V}$	500	nA

PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	OE	Output enable input (active-Low)
2, 3, 4, 5, 6, 7, 8, 9, 10	$\text{D}0\text{-D}8$	Data inputs
23, 22, 21, 20, 19, 18, 17, 16, 15	$\text{Q}0\text{-Q}8$	Data outputs
11	MR	Master reset input (active-Low)
13	LE	Latch enable input (active rising edge)
14	PRE	Preset input (active-Low)
12	GND	Ground (0V)
24	V_{CC}	Positive supply voltage

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LOGIC SYMBOL**LOGIC SYMBOL (IEEE/IEC)****FUNCTION TABLE**

INPUTS					OUTPUTS		OPERATING MODE
OE	PRE	MR	LE	D _n	Q _n		
L	L	X	X	X	H		Preset
L	H	L	X	X	L		Clear
L	H	H	H	L	L		Transparent
L	H	H	↓	I	L		Latched
H	X	X	X	X	Z		High impedance
L	H	H	L	X	NC		Hold

H = High voltage level

h = High voltage level one set-up time prior to the High-to-Low LE transition

L = Low voltage level

I = Low voltage level one set-up time prior to the High-to-Low LE transition

NC = No change

X = Don't care

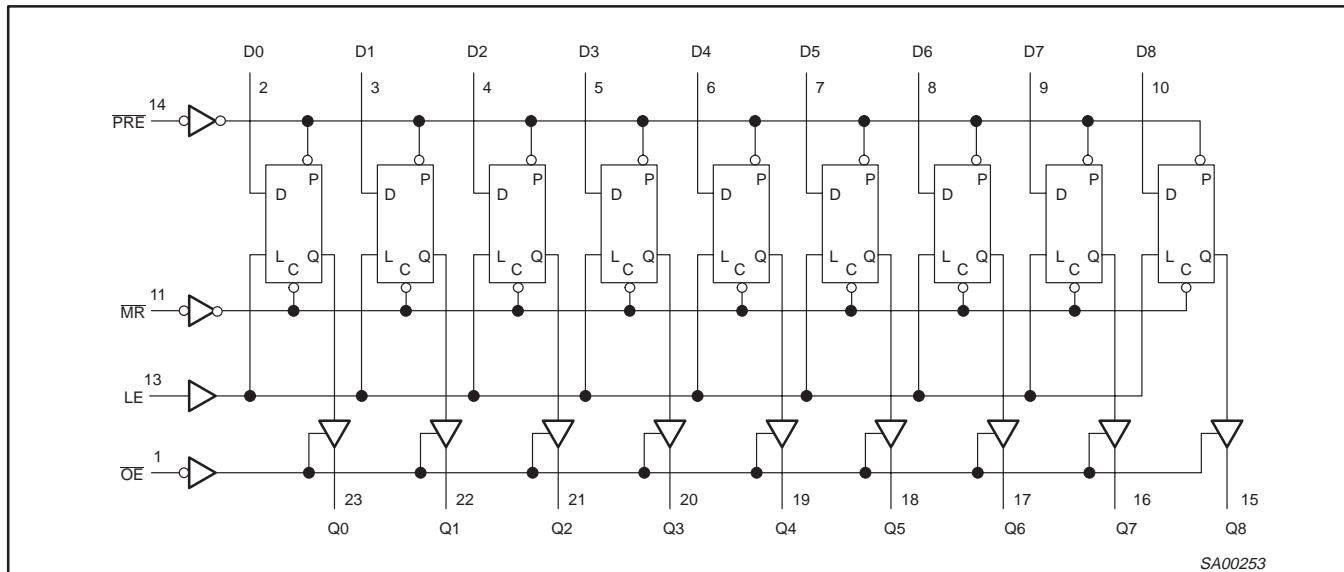
Z = High impedance "off" state

↓ = High-to-Low transition

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LOGIC DIAGRAM



SA00253

ABSOLUTE MAXIMUM RATINGS^{1,2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		-0.5 to +7.0	V
I_{IK}	DC input diode current	$V_I < 0$	-18	mA
V_I	DC input voltage ³		-1.2 to +7.0	V
I_{OK}	DC output diode current	$V_O < 0$	-50	mA
V_{OUT}	DC output voltage ³	output in Off or High state	-0.5 to +5.5	V
I_{OUT}	DC output current	output in Low state	128	mA
T_{stg}	Storage temperature range		-65 to 150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		Min	Max	
V_{CC}	DC supply voltage	4.5	5.5	V
V_I	Input voltage	0	V_{CC}	V
V_{IH}	High-level input voltage	2.0		V
V_{IL}	Low-level input voltage		0.8	V
I_{OH}	High-level output current		-32	mA
I_{OL}	Low-level output current		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V
T_{amb}	Operating free-air temperature range	-40	+85	°C

DC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			$T_{amb} = +25^{\circ}\text{C}$		$T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	
			Min	Typ	Max	
V_{IK}	Input clamp voltage	$V_{CC} = 4.5\text{V}$; $I_{IK} = -18\text{mA}$		-0.9	-1.2	-1.2
V_{OH}	High-level output voltage	$V_{CC} = 4.5\text{V}$; $I_{OH} = -3\text{mA}$; $V_I = V_{IL}$ or V_{IH}	2.5	2.9		V
		$V_{CC} = 5.0\text{V}$; $I_{OH} = -3\text{mA}$; $V_I = V_{IL}$ or V_{IH}	3.0	3.4		V
		$V_{CC} = 4.5\text{V}$; $I_{OH} = -32\text{mA}$; $V_I = V_{IL}$ or V_{IH}	2.0	2.4		V
V_{OL}	Low-level output voltage	$V_{CC} = 4.5\text{V}$; $I_{OL} = 64\text{mA}$; $V_I = V_{IL}$ or V_{IH}		0.42	0.55	0.55
V_{RST}	Power-up output low voltage ³	$V_{CC} = 5.5\text{V}$; $I_O = 1\text{mA}$; $V_I = V_{CC}$ or GND		0.13	0.55	0.55
I_I	Input leakage current	$V_{CC} = 5.5\text{V}$; $V_I = \text{GND}$ or 5.5V		± 0.01	± 1.0	± 1.0
I_{OFF}	Power-off leakage current	$V_{CC} = 0.0\text{V}$; V_O or $V_I \leq 4.5\text{V}$		± 5.0	± 100	± 100
$I_{PU/ID}$	Power-up/down 3-state output current ⁴	$V_{CC} = 2.0\text{V}$; $V_O = 0.5\text{V}$; $V_{OE} = V_{CC}$; $V_I = \text{GND}$ or V_{CC}		± 5.0	± 50	± 50
I_{OZH}	3-State output High current	$V_{CC} = 5.5\text{V}$; $V_O = 2.7\text{V}$; $V_I = V_{IL}$ or V_{IH}		5.0	50	50
I_{OZL}	3-State output Low current	$V_{CC} = 5.5\text{V}$; $V_O = 0.5\text{V}$; $V_I = V_{IL}$ or V_{IH}		-5.0	-50	-50
I_{CEX}	Output high leakage current	$V_{CC} = 5.5\text{V}$; $V_O = 5.5\text{V}$; $V_I = \text{GND}$ or V_{CC}		5.0	50	50
I_O	Output current ¹	$V_{CC} = 5.5\text{V}$; $V_O = 2.5\text{V}$	-50	-80	-180	mA
I_{CCH}	Quiescent supply current	$V_{CC} = 5.5\text{V}$; Outputs High, $V_I = \text{GND}$ or V_{CC}		0.5	250	250
I_{CCL}		$V_{CC} = 5.5\text{V}$; Outputs Low, $V_I = \text{GND}$ or V_{CC}		25	34	34
I_{CCZ}		$V_{CC} = 5.5\text{V}$; Outputs 3-State; $V_I = \text{GND}$ or V_{CC}		0.5	250	250
ΔI_{CC}	Additional supply current per input pin ²	$V_{CC} = 5.5\text{V}$; one input at 3.4V , other inputs at V_{CC} or GND		0.5	1.5	1.5

NOTES:

1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
2. This is the increase in supply current for each input at 3.4V .
3. For valid test results, data must not be loaded into the flip-flops (or latches) after applying the power.
4. This parameter is valid for any V_{CC} between 0V and 2.1V with a transition time of up to 10msec . For $V_{CC} = 2.1\text{V}$ to $V_{CC} = 5\text{V} \pm 10\%$, a transition time of up to $100\mu\text{sec}$ is permitted.

9-bit bus interface latch with set and reset (3-State)

74ABT843

AC CHARACTERISTICS

SYMBOL	PARAMETER	WAVEFORM	LIMITS					UNIT	
			T _{amb} = +25°C V _{CC} = +5.0V			T _{amb} = -40 to +85°C V _{CC} = +5.0V ± 0.5V			
			Min	Typ	Max	Min	Max		
t _{PLH} t _{PHL}	Propagation delay Dn to Qn	1	1.6 2.2	3.6 5.0	5.2 6.3	1.6 2.2	6.0 7.2	ns	
t _{PLH} t _{PHL}	Propagation delay LE to Qn	2	2.0 2.8	4.1 4.8	5.6 6.3	2.0 2.8	6.5 6.9	ns	
t _{PLH} t _{PHL}	Propagation delay PRE to Qn	1	2.2 3.0	4.7 5.2	6.2 6.5	2.2 3.0	7.4 7.2	ns	
t _{PLH} t _{PHL}	Propagation delay MR to Qn	1	2.5 3.1	5.0 5.5	6.3 6.8	2.5 3.1	7.1 8.0	ns	
t _{PZH} t _{PZL}	Output enable time OE to Qn	4 5	1.0 2.0	2.7 4.2	4.2 5.5	1.0 2.0	5.2 6.5	ns	
t _{PHZ} t _{PLZ}	Output disable time OE to Qn	4 5	2.9 2.2	4.9 5.0	6.2 6.3	2.9 2.2	6.8 6.7	ns	

AC SETUP REQUIREMENTS

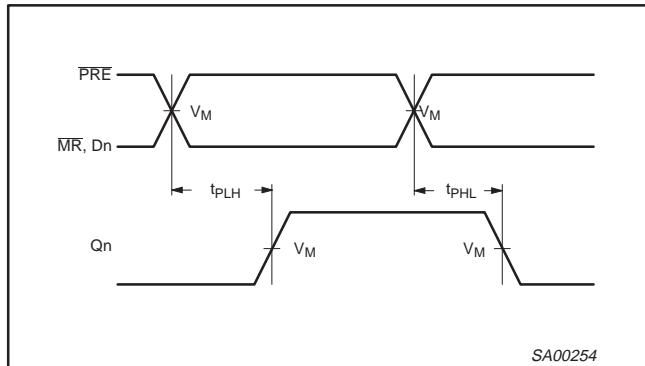
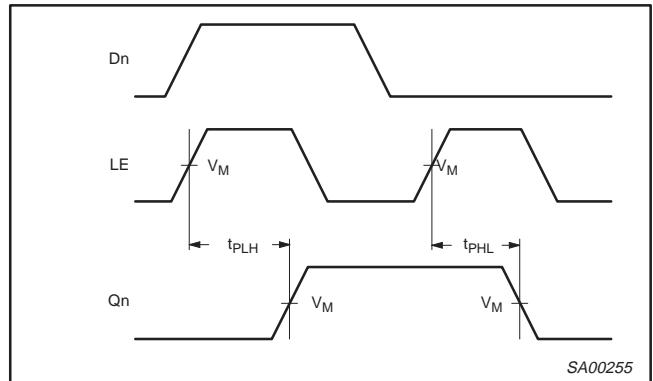
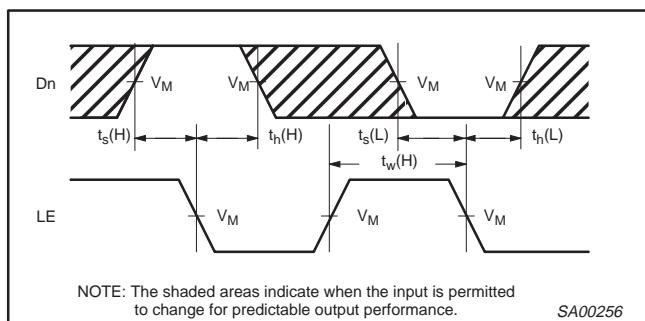
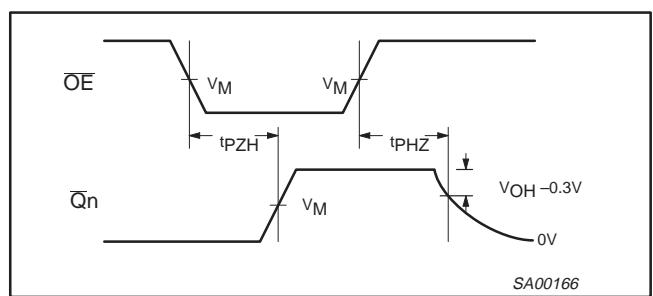
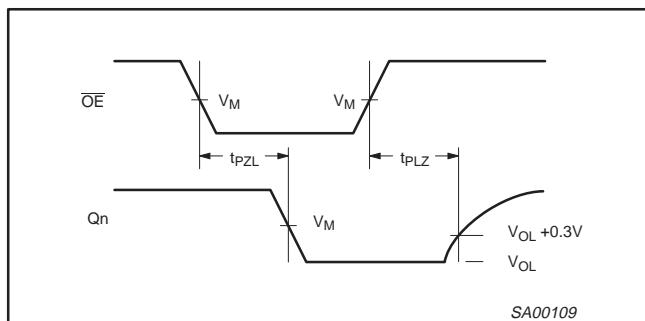
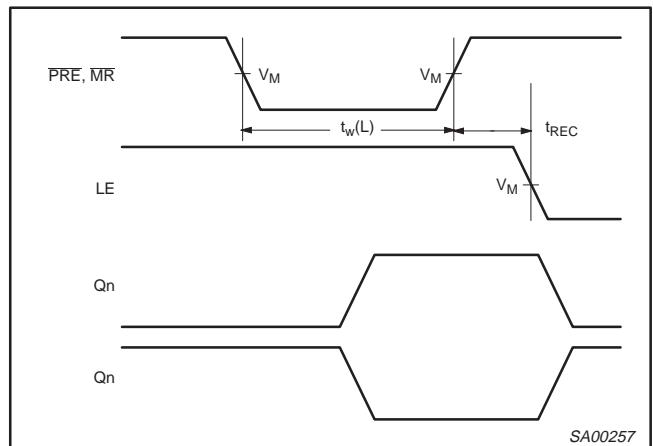
GND = 0V, t_R = t_F = 2.5ns, C_L = 50pF, R_L = 500Ω

SYMBOL	PARAMETER	WAVEFORM	LIMITS			UNIT
			T _{amb} = +25°C V _{CC} = +5.0V		Min	
			Typ	Min	Min	
t _{s(H)} t _{s(L)}	Setup time, High or Low Dn to LE	3	2.5 3.0	1.1 1.3	2.5 3.0	ns
t _{h(H)} t _{h(L)}	Hold time, High or Low Dn to LE	3	1.0 1.0	-1.0 -1.0	1.0 1.0	ns
t _{w(H)}	LE pulse width, High	3	3.3	1.8	3.3	ns
t _{w(L)}	PRE pulse width, Low	6	4.5	3.0	4.5	ns
t _{w(L)}	MR pulse width, Low	6	5.5	4.0	5.5	ns
t _{rec}	PRE recovery time	6	2.9	1.6	2.9	ns
t _{rec}	MR recovery time	6	3.6	2.0	3.6	ns

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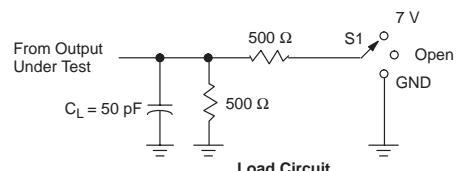
AC WAVEFORMS

 $V_M = 1.5V$, $V_{IN} = GND$ to $3.0V$ Waveform 1. Propagation Delay, Data to Output,
Master Reset to Output, Preset to OutputWaveform 2. Propagation Delay, Latch Enable
to OutputWaveform 3. Data Setup and Hold Times and Latch Enable
Pulse WidthWaveform 4. 3-State Output Enable Time to High Level and
Output Disable Time from High LevelWaveform 5. 3-State Output Enable Time to Low Level and
Output Disable Time from Low LevelWaveform 6. Master Reset and Preset Pulse Width,
Master Reset and Preset to Latch Enable Recovery Time

TEST CIRCUIT AND WAVEFORM

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TEST	S1
t_{pd}	open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	open

DEFINITIONS

C_L = Load capacitance includes jig and probe capacitance;
see AC CHARACTERISTICS for value.

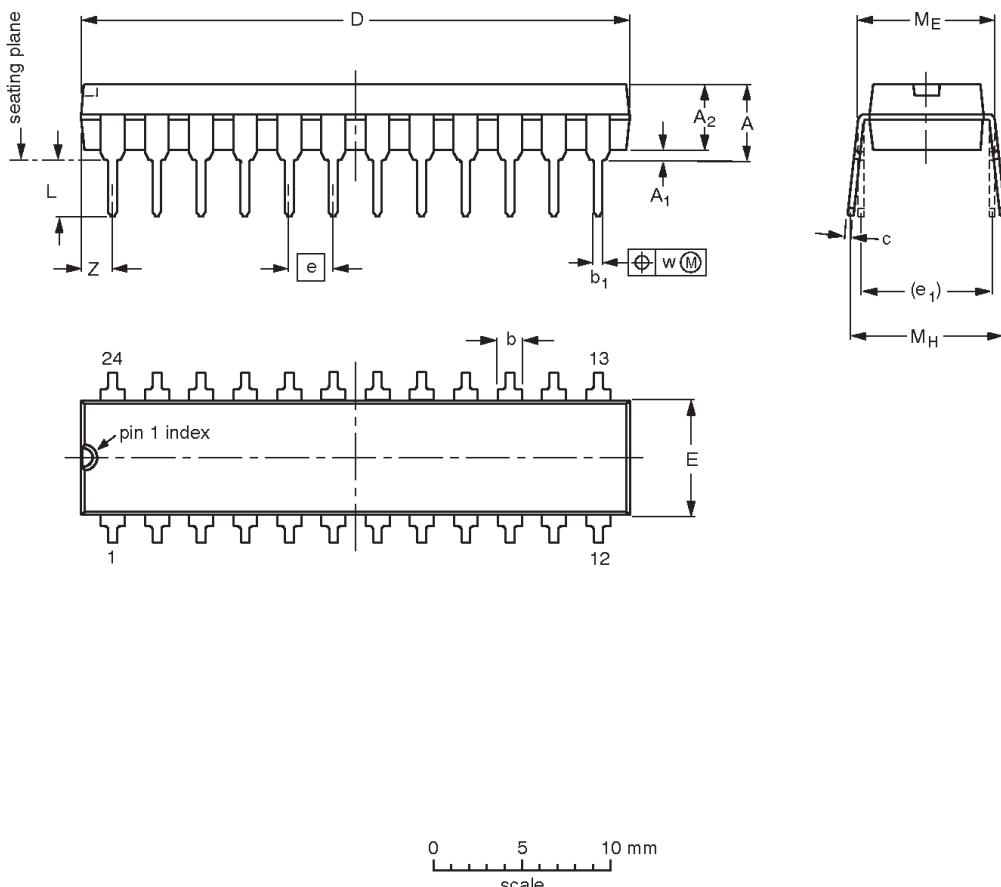
SA00012

9-bit bus interface latch with set and reset (3-State)

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DIP24: plastic dual in-line package; 24 leads (300 mil)

SOT222-1



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A max.	A_1 min.	A_2 max.	b	b_1	c	$D^{(1)}$	$E^{(1)}$	e	e_1	L	M_E	M_H	w	$Z^{(1)}$ max.
mm	4.70	0.38	3.94	1.63 1.14	0.56 0.43	0.36 0.25	31.9 31.5	6.73 6.48	2.54	7.62	3.51 3.05	8.13 7.62	10.03 7.62	0.25	2.05
inches	0.185	0.015	0.155	0.064 0.045	0.022 0.017	0.014 0.010	1.256 1.240	0.265 0.255	0.100	0.300	0.138 0.120	0.32 0.30	0.395 0.300	0.01	0.081

Note

1. Plastic or metal protrusions of 0.01 inches maximum per side are not included.

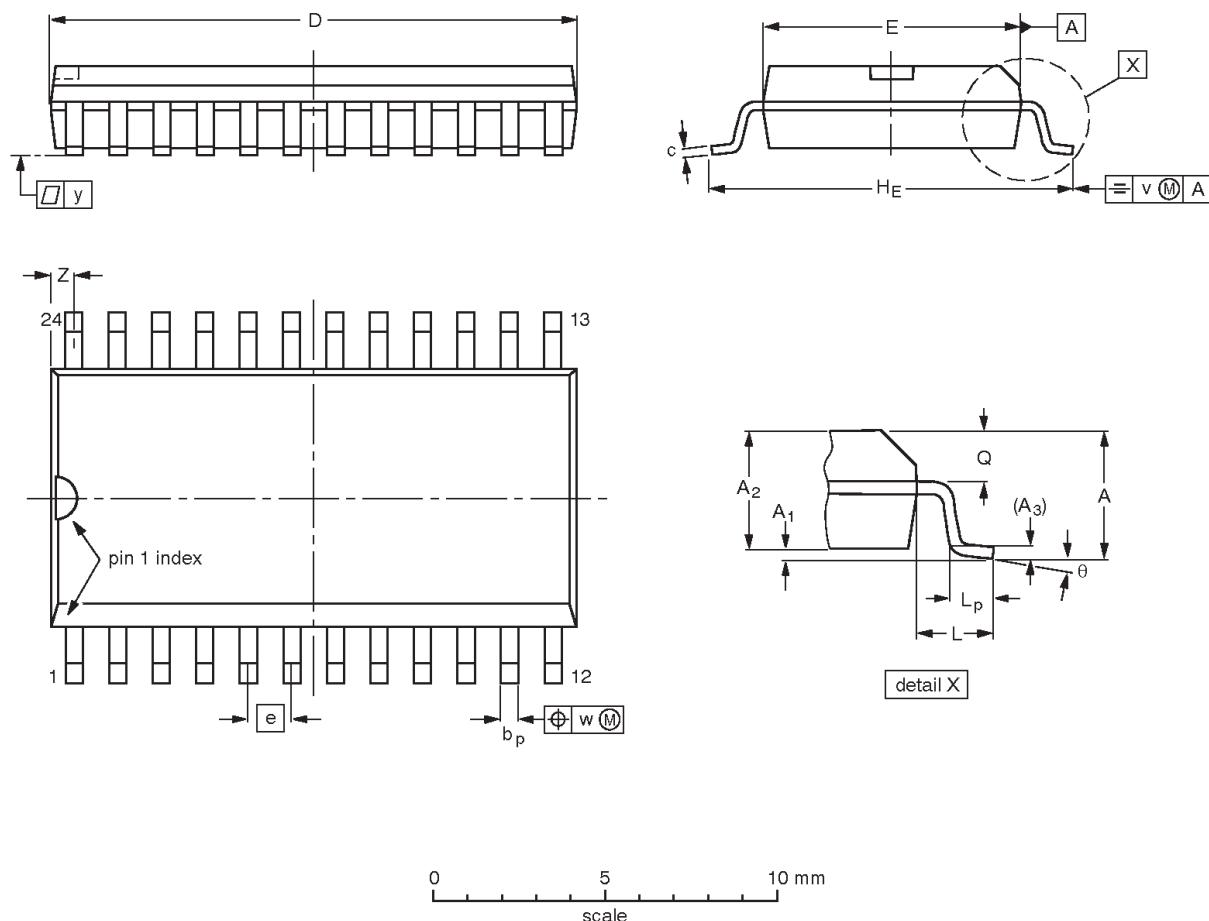
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT222-1		MS-001AF				95-03-11

9-bit bus interface latch with set and reset (3-State)

74ABT843

SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	2.65 0.10	0.30 2.25	2.45	0.25	0.49 0.36	0.32 0.23	15.6 15.2	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.10 0.004	0.012 0.089	0.096	0.01	0.019 0.014	0.013 0.009	0.61 0.60	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

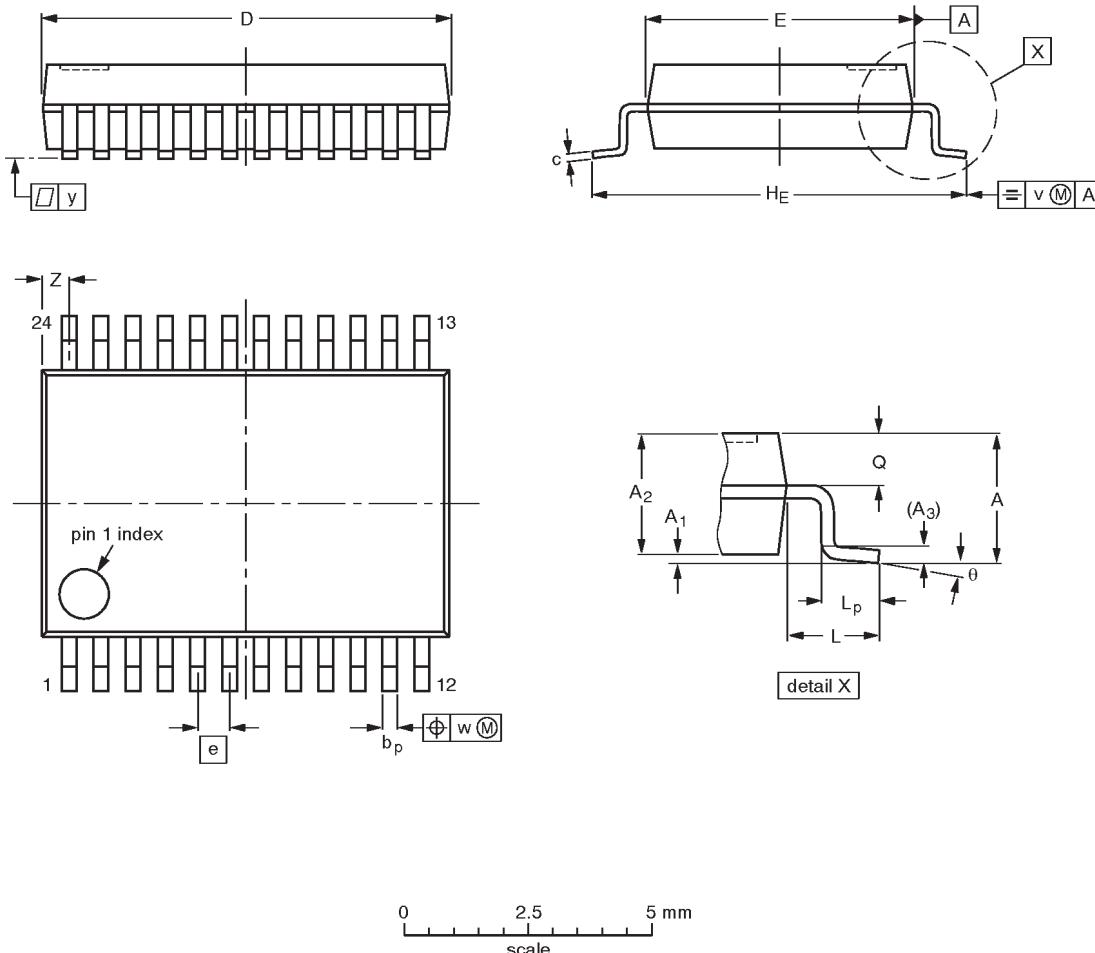
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	IEC	JEDEC	EIAJ		
SOT137-1	075E05	MS-013AD			-95-01-24 97-05-22

9-bit bus interface latch with set and reset (3-State)

74ABT843

SSOP24: plastic shrink small outline package; 24 leads; body width 5.3 mm

SOT340-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	2.0 0.05	0.21 1.65	1.80	0.25	0.38 0.25	0.20 0.09	8.4 8.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.8 0.4	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

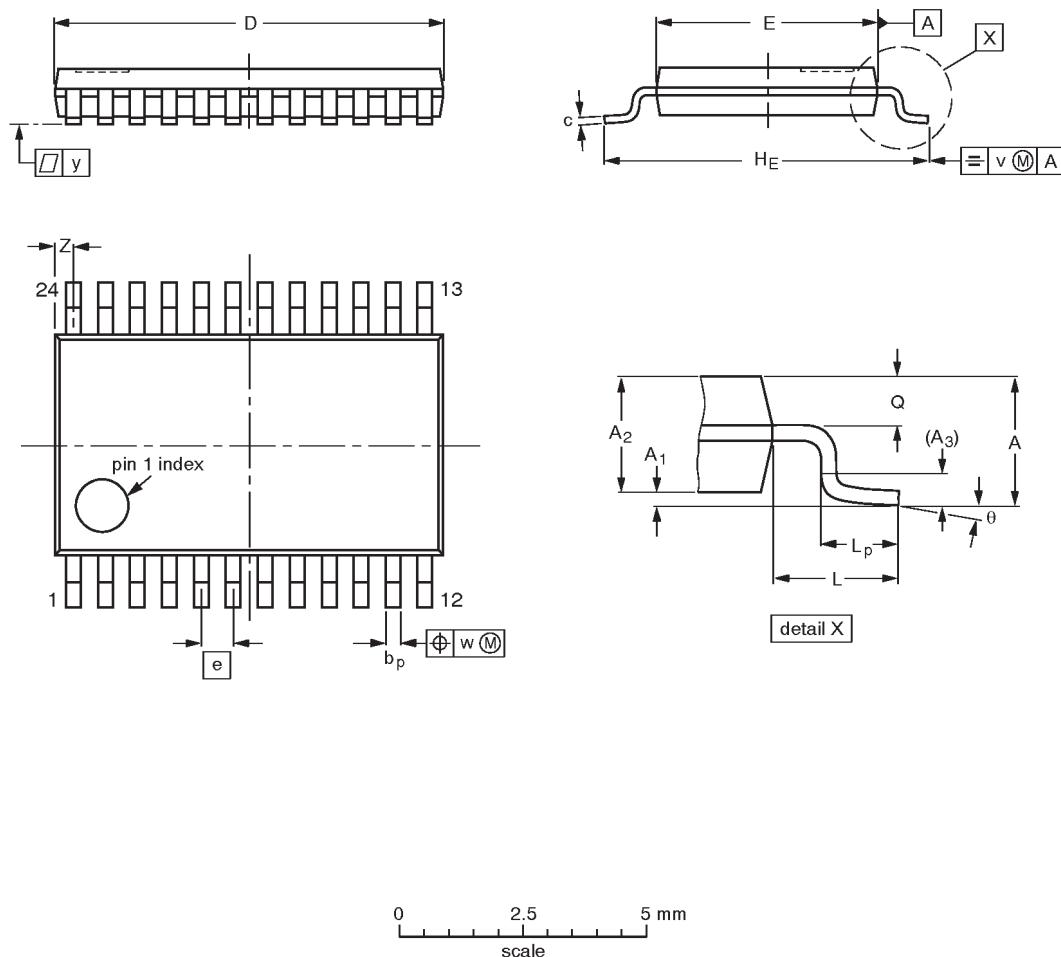
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT340-1		MO-150AG				93-09-08 95-02-04

9-bit bus interface latch with set and reset (3-State)

74ABT843

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	1.10 0.05	0.15 0.080	0.95 0.80	0.25 0.19	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65 0.65	6.6 6.2	1.0 0.50	0.75 0.50	0.4 0.3	0.2 0.2	0.13 0.13	0.1 0.1	0.5 0.2	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT355-1		MO-153AD				-93-06-16 95-02-04

9-bit bus interface latch with set and reset
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NOTES

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Data sheet status

Data sheet status	Product status	Definition ^[1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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